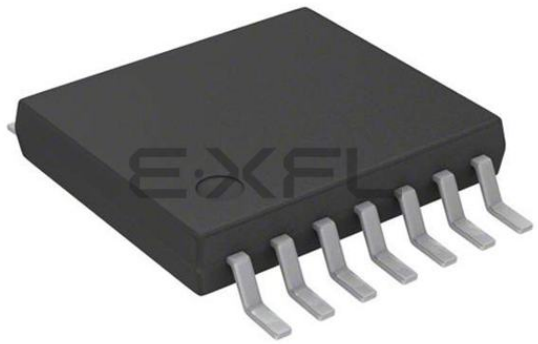

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	12
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	FLASH
EEPROM Size	224 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 11x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf15323-e-st

TABLE 1-2: PIC16(L)F15313 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
OUT(2)	C1OUT	—	CMOS/OD	Comparator 1 output.
	SDO1	—	CMOS/OD	MSSP1 SPI serial data output.
	SCK1	—	CMOS/OD	MSSP1 SPI serial clock output.
	DT1(3)	—	CMOS/OD	EUSART Synchronous mode data output.
	TX1	—	CMOS/OD	EUSART1 Asynchronous mode transmitter data output.
	CK1	—	CMOS/OD	EUSART1 Synchronous mode clock output.
	SCL1(3,4)	—	CMOS/OD	MSSP1 I^2C output.
	SDA1(3,4)	—	CMOS/OD	MSSP1 I^2C output.
	TMR0	—	CMOS/OD	Timer0 output.
	CCP1	—	CMOS/OD	CCP1 output (compare/PWM functions).
	CCP2	—	CMOS/OD	CCP2 output (compare/PWM functions).
	PWM3OUT	—	CMOS/OD	PWM3 output.
	PWM4OUT	—	CMOS/OD	PWM4 output.
	PWM5OUT	—	CMOS/OD	PWM5 output.
	PWM6OUT	—	CMOS/OD	PWM6 output.
	CWG1A	—	CMOS/OD	Complementary Waveform Generator 1 output A.
	CWG1B	—	CMOS/OD	Complementary Waveform Generator 1 output B.
	CWG1C	—	CMOS/OD	Complementary Waveform Generator 1 output C.
	CWG1D	—	CMOS/OD	Complementary Waveform Generator 1 output D.
	CLC1OUT	—	CMOS/OD	Configurable Logic Cell 1 output.
	CLC2OUT	—	CMOS/OD	Configurable Logic Cell 2 output.
	CLC3OUT	—	CMOS/OD	Configurable Logic Cell 3 output.
	CLC4OUT	—	CMOS/OD	Configurable Logic Cell 4 output.
	NCO1OUT	—	CMOS/OD	Numerically Controller Oscillator output.
	CLKR	—	CMOS/OD	Clock Reference module output.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open-Drain
TTL = TTL compatible input; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C
HV = High Voltage; XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 15-3 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 15-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

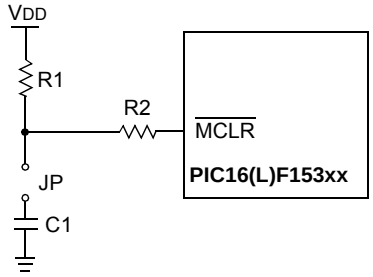
2.3 Master Clear ($\overline{MCLR}$) Pin

The $\overline{MCLR}$ pin provides two specific device functions: Device Reset, and Device Programming and Debugging. If programming and debugging are not required in the end application, a direct connection to VDD may be all that is required. The addition of other components, to help increase the application's resistance to spurious Resets from voltage sags, may be beneficial. A typical configuration is shown in Figure 2-1. Other circuit designs may be implemented, depending on the application's requirements.

During programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the $\overline{MCLR}$ pin. Consequently, specific voltage levels (VIH and VIL) and fast signal transitions must not be adversely affected. Therefore, specific values of R1 and C1 will need to be adjusted based on the application and PCB requirements. For example, it is recommended that the capacitor, C1, be isolated from the $\overline{MCLR}$ pin during programming and debugging operations by using a jumper (Figure 2-2). The jumper is replaced for normal run-time operations.

Any components associated with the $\overline{MCLR}$ pin should be placed within 0.25 inch (6 mm) of the pin.

FIGURE 2-2: EXAMPLE OF $\overline{MCLR}$ PIN CONNECTIONS



Note 1: R1 ≤ 10 kΩ is recommended. A suggested starting value is 10 kΩ. Ensure that the $\overline{MCLR}$ pin VIH and VIL specifications are met.

2: R2 ≤ 470Ω will limit any current flowing into $\overline{MCLR}$ from the external capacitor, C1, in the event of $\overline{MCLR}$ pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the $\overline{MCLR}$ pin VIH and VIL specifications are met.

2.4 ICSP™ Pins

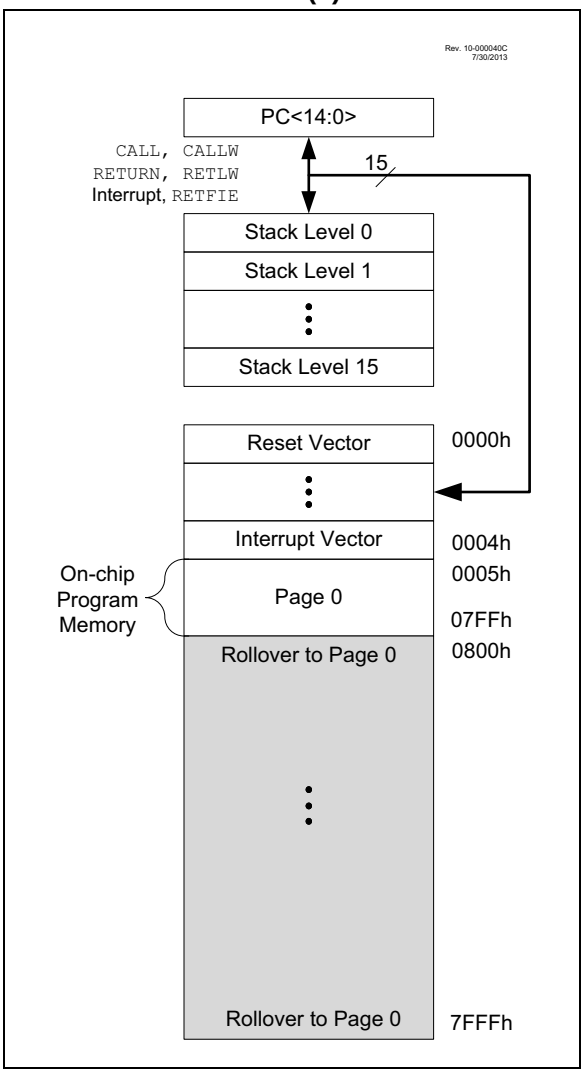
The ICSPCLK and ICSPDAT pins are used for In-Circuit Serial Programming™ (ICSP™) and debugging purposes. It is recommended to keep the trace length between the ICSP connector and the ICSP pins on the device as short as possible. If the ICSP connector is expected to experience an ESD event, a series resistor is recommended, with the value in the range of a few tens of ohms, not to exceed 100Ω.

Pull-up resistors, series diodes and capacitors on the ICSPCLK and ICSPDAT pins are not recommended as they will interfere with the programmer/debugger communications to the device. If such discrete components are an application requirement, they should be removed from the circuit during programming and debugging. Alternatively, refer to the AC/DC characteristics and timing requirements information in the respective device Flash programming specification for information on capacitive loading limits, and pin input voltage high (VIH) and input low (VIL) requirements.

For device emulation, ensure that the "Communication Channel Select" (i.e., ICSPCLK/ICSPDAT pins), programmed into the device, matches the physical connections for the ICSP to the Microchip debugger/emulator tool.

For more information on available Microchip development tools connection requirements, refer to **Section 39.0 "Development Support"**.

FIGURE 4-1: PROGRAM MEMORY MAP AND STACK FOR PIC16(L)F15313/23



4.1.1 READING PROGRAM MEMORY AS DATA

There are three methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set an FSR to point to the program memory. The third method is to use the NVMREG interface to access the program memory. For an example of NVMREG interface use, reference Section 13.3, NVMREG Access.

4.1.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 4-1.

EXAMPLE 4-1: RETLW INSTRUCTION

```
constants
    BRW                 ;Add Index in W to
                        ;program counter to
                        ;select data
    RETLW DATA0         ;Index0 data
    RETLW DATA1         ;Index1 data
    RETLW DATA2
    RETLW DATA3


my_function
    ;… LOTS OF CODE…
    MOVLW       DATA_INDEX
    call constants
    ;… THE CONSTANT IS IN W
```

The BRW instruction makes this type of table very simple to implement.

4.1.1.2 Indirect Read with FSR

The program memory can be accessed as data by setting bit 7 of an FSRxH register and reading the matching INDFx register. The MOVIW instruction will place the lower eight bits of the addressed word in the W register. Writes to the program memory cannot be performed via the INDF registers. Instructions that read the program memory via the FSR require one extra instruction cycle to complete. Example 4-2 demonstrates reading the program memory via an FSR.

TABLE 4-10: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 11											
CPU CORE REGISTERS; see Table 4-3 for specifics											
58Ch	NCO1ACCL	NCO1ACC<7:0>								0000 0000	0000 0000
58Dh	NCO1ACCH	NCO1ACC<15:8>								0000 0000	0000 0000
58Eh	NCO1ACCU	—	—	—	—	NCO1ACC<19:16>				---- 0000	---- 0000
58Fh	NCO1INCL	NCO1INC<7:0>								0000 0001	0000 0001
590h	NCO1INCH	NCO1INC<15:8>								0000 0000	0000 0000
591h	NCO1INCU	—	—	—	—	NCO1INC<19:16>				---- 0000	---- 0000
592h	NCO1CON	N1EN	—	N1OUT	N1POL	—	—	—	N1PFM	0-00 ---0	0-00 ---0
593h	NCO1CLK	N1PWS<2:0>			—	—	N1CKS<2:0>			000- -000	000- -000
594h	—	Unimplemented								—	—
595h	—	Unimplemented								—	—
596h	—	Unimplemented								—	—
597h	—	Unimplemented								—	—
598h	—	Unimplemented								—	—
599h	—	Unimplemented								—	—
59Ah	—	Unimplemented								—	—
59Bh	—	Unimplemented								—	—
59Ch	TMR0L	Holding Register for the Least Significant Byte of the 16-bit TMR0 Register								0000 0000	0000 0000
59Dh	TMR0H	Holding Register for the Most Significant Byte of the 16-bit TMR0 Register								1111 1111	1111 1111
59Eh	T0CON0	T0EN	—	T0OUT	T016BIT	T0OUTPS<3:0>				0-00 0000	0-00 0000
59Fh	T0CON1	T0CS<2:0>			T0ASYNC	T0CKPS<3:0>				0000 0000	0000 0000

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

8.12 Memory Execution Violation

A Memory Execution Violation Reset occurs if executing an instruction being fetched from outside the valid execution area. The different valid execution areas are defined as follows:

- Flash Memory: Table 4-1 shows the addresses available on the PIC16(L)F15313/23 devices based on user Flash size. Execution outside this region generates a memory execution violation.
- Storage Area Flash (SAF): If Storage Area Flash (SAF) is enabled (**Section 4.2.3 “Storage Area Flash”**), the SAF area (Table 4-2) is not a valid execution area.

Prefetched instructions that are not executed do not cause memory execution violations. For example, a GOTO instruction in the last memory location will prefetch from an invalid location; this is not an error. If an instruction from an invalid location tries to execute, the memory violation is generated immediately, and any concurrent interrupt requests are ignored. When a memory execution violation is generated, the device is reset and flag $\overline{\text{MEMV}}$ is cleared in PCON1 (Register 8-3) to signal the cause. The flag needs to be set in code after a memory execution violation.

8.14 Power Control (PCONx) Registers

The Power Control (PCONx) registers contain flag bits to differentiate between a:

- Power-on Reset ($\overline{POR}$)
- Brown-out Reset ($\overline{BOR}$)
- Reset Instruction Reset ($\overline{RI}$)
- $\overline{MCLR}$ Reset ($\overline{RMCLR}$)
- Watchdog Timer Reset ($\overline{RWDT}$)
- Watchdog Timer Window Violation Reset ($\overline{WDTWV}$)
- Stack Underflow Reset (STKUNF)
- Stack Overflow Reset (STKOVF)
- Memory Violation Reset ($\overline{MEMV}$)

The PCON0 register bits are shown in Register 8-2. The PCON1 register bits are shown in Register 8-3.

Hardware will change the corresponding register bit during the Reset process; if the Reset was not caused by the condition, the bit remains unchanged (Table 8-4).

Software should reset the bit to the inactive state after the restart (hardware will not reset the bit).

Software may also set any PCON bit to the active state, so that user code may be tested, but no reset action will be generated.

REGISTER 10-6: PIE4: PERIPHERAL INTERRUPT ENABLE REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
—	—	—	—	—	—	TMR2IE	TMR1IE
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS = Hardware set

bit 7-2 **Unimplemented:** Read as ‘0’

bit 1 **TMR2IE:** TMR2 to PR2 Match Interrupt Enable bit
- 1 = Enables the Timer2 to PR2 match interrupt
- 0 = Disables the Timer2 to PR2 match interrupt

bit 0 **TMR1IE:** Timer1 Overflow Interrupt Enable bit
- 1 = Enables the Timer1 overflow interrupt
- 0 = Enables the Timer1 overflow interrupt

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt controlled by registers PIE1-PIE7.

11.1.2 INTERRUPTS DURING DOZE

If an interrupt occurs and the Recover-on-Interrupt bit is clear (ROI = 0) at the time of the interrupt, the Interrupt Service Routine (ISR) continues to execute at the rate selected by DOZE<2:0>. Interrupt latency is extended by the DOZE<2:0> ratio.

If an interrupt occurs and the ROI bit is set (ROI = 1) at the time of the interrupt, the DOZEN bit is cleared and the CPU executes at full speed. The prefetched instruction is executed and then the interrupt vector sequence is executed. In Figure 11-1, the interrupt occurs during the 2nd instruction cycle of the Doze period, and immediately brings the CPU out of Doze. If the Doze-On-Exit (DOE) bit is set (DOE = 1) when the RETFIE operation is executed, DOZEN is set, and the CPU executes at the reduced rate based on the DOZE<2:0> ratio.

11.2 Sleep Mode

Sleep mode is entered by executing the SLEEP instruction, while the Idle Enable (IDLEN) bit of the CPUDOZE register is clear (IDLEN = 0). If the SLEEP instruction is executed while the IDLEN bit is set (IDLEN = 1), the CPU will enter the IDLE mode (**Section 11.2.3 “Low-Power Sleep Mode”**).

Upon entering Sleep mode, the following conditions exist:

1. WDT will be cleared but keeps running if enabled for operation during Sleep
2. The $\overline{PD}$ bit of the STATUS register is cleared
3. The $\overline{TO}$ bit of the STATUS register is set
4. CPU Clock and System Clock
5. 31 kHz LFINTOSC, HFINTOSC are unaffected and peripherals using them may continue operation in Sleep.
6. ADC is unaffected if the dedicated FRC oscillator is selected the conversion will be left abandoned if FOSC is selected and ADRES will have an incorrect value
7. I/O ports maintain the status they had before Sleep was executed (driving high, low, or high-impedance). This does not apply in the case of any asynchronous peripheral which is active and may affect the I/O port value
8. Resets other than WDT are not affected by Sleep mode

Refer to individual chapters for more details on peripheral operation during Sleep.

To minimize current consumption, the following conditions should be considered:

- I/O pins should not be floating
- External circuitry sinking current from I/O pins
- Internal circuitry sourcing current from I/O pins
- Current draw from pins with internal weak pull-ups
- Modules using any oscillator

I/O pins that are high-impedance inputs should be pulled to VDD or VSS externally to avoid switching currents caused by floating inputs.

Any module with a clock source that is not FOSC can be enabled. Examples of internal circuitry that might be sourcing current include modules such as the DAC and FVR modules. See **Section 21.0 “5-Bit Digital-to-Analog Converter (DAC1) Module”**, **Section 18.0 “Fixed Voltage Reference (FVR)”** for more information on these modules.

11.2.1 WAKE-UP FROM SLEEP

The device can wake-up from Sleep through one of the following events:

1. External Reset input on $\overline{MCLR}$ pin, if enabled.
2. BOR Reset, if enabled.
3. POR Reset.
4. Watchdog Timer, if enabled.
5. Any external interrupt.
6. Interrupts by peripherals capable of running during Sleep (see individual peripheral for more information).

The first three events will cause a device Reset. The last three events are considered a continuation of program execution. To determine whether a device Reset or wake-up event occurred, refer to **Section 8.12 “Memory Execution Violation”**.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is prefetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be enabled. Wake-up will occur regardless of the state of the GIE bit. If the GIE bit is disabled, the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is enabled, the device executes the instruction after the SLEEP instruction, the device will then call the Interrupt Service Routine. In cases where the execution of the instruction following SLEEP is not desirable, the user should have a NOP after the SLEEP instruction.

The WDT is cleared when the device wakes-up from Sleep, regardless of the source of wake-up.

TABLE 12-3: SUMMARY OF REGISTERS ASSOCIATED WITH WATCHDOG TIMER

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON1	—	NOSC<2:0>			NDIV<3:0>				110
OSCCON2	—	COSC<2:0>			CDIV<3:0>				110
OSCCON3	CSWHOLD	—	—	ORDY	NOSCR	—	—	—	111
PCON0	STKOVF	STKUNF	$\overline{\text{WDTWV}}$	$\overline{\text{RWDT}}$	$\overline{\text{RMCLR}}$	$\overline{\text{RI}}$	$\overline{\text{POR}}$	$\overline{\text{BOR}}$	99
STATUS	—	—	—	$\overline{\text{TO}}$	$\overline{\text{PD}}$	Z	DC	C	32
WDTCON0	—	—	WDTPS<4:0>					SWDTEN	150
WDTCON1	—	WDTCS<2:0>			—	WINDOW<2:0>			151
WDTPSL	PSCNT<7:0>								152
WDTPSH	PSCNT<15:8>								152
WDTTMR	—	WDTTMR<4:0>				STATE	PSCNT<17:16>		152

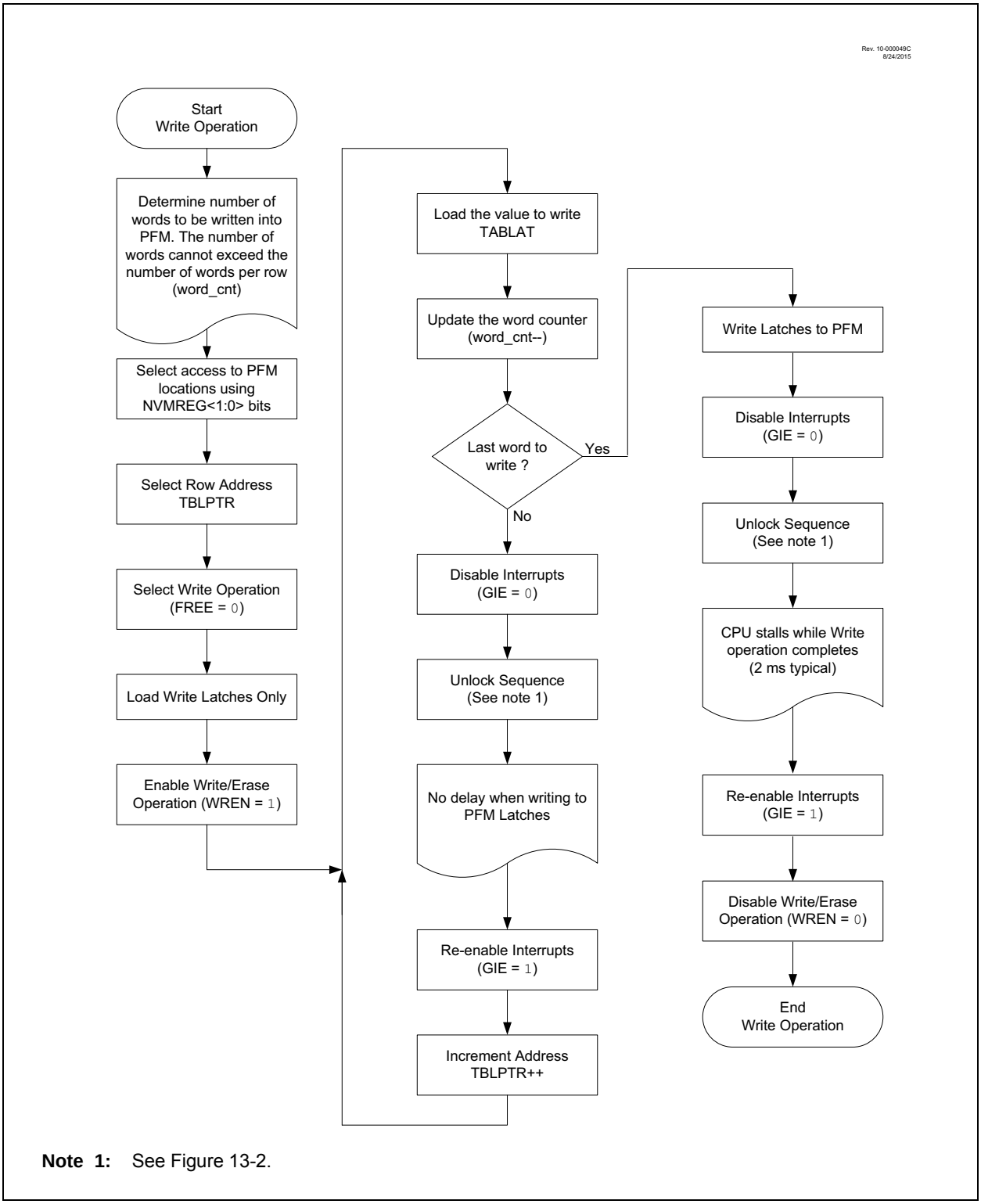
Legend: – = unimplemented locations read as '0'. Shaded cells are not used by Watchdog Timer.

TABLE 12-4: SUMMARY OF CONFIGURATION WORD WITH WATCHDOG TIMER

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	FCMEN	—	CSWEN	—	—	$\overline{\text{CLKOUTEN}}$	76
	7:0	—	RSTOSC<2:0>			—	FEXTOSC<2:0>			

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by Watchdog Timer.

FIGURE 13-5: PROGRAM FLASH MEMORY WRITE FLOWCHART



Note 1: See Figure 13-2.

REGISTER 13-5: NVMCON1: NONVOLATILE MEMORY CONTROL 1 REGISTER

U-0	R/W-0/0	R/W-0/0	R/W/HC-0/0	R/W/HC-x/q	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
—	NVMREGS	LWLO	FREE	WRERR(1,2,3)	WREN	WR(4,5,6)	RD
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
S = Bit can only be set	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **Unimplemented:** Read as '0'

bit 6 **NVMREGS:** Configuration Select bit
1 = Access DIA, DCI, Configuration, User ID and Device ID Registers
0 = Access PFM

bit 5 **LWLO:** Load Write Latches Only bit
When FREE = 0:
1 = The next WR command updates the write latch for this word within the row; no memory operation is initiated.
0 = The next WR command writes data or erases
Otherwise: The bit is ignored

bit 4 **FREE:** PFM Erase Enable bit
When NVMREGS:NVMADR points to a PFM location:
1 = Performs an erase operation with the next WR command; the 32-word pseudo-row containing the indicated address is erased (to all 1s) to prepare for writing.
0 = All erase operations have completed normally

bit 3 **WRERR:** Program/Erase Error Flag bit(1,2,3)
This bit is normally set by hardware.
1 = A write operation was interrupted by a Reset, interrupted unlock sequence, or WR was written to one while NVMADR points to a write-protected address.
0 = The program or erase operation completed normally

bit 2 **WREN:** Program/Erase Enable bit
1 = Allows program/erase cycles
0 = Inhibits programming/erasing of program Flash

bit 1 **WR:** Write Control bit(4,5,6)
When NVMREG:NVMADR points to a PFM location:
1 = Initiates the operation indicated by Table 13-4
0 = NVM program/erase operation is complete and inactive.

bit 0 **RD:** Read Control bit(7)
1 = Initiates a read at address = NVMADR1, and loads data to NVMDAT Read takes one instruction cycle and the bit is cleared when the operation is complete. The bit can only be set (not cleared) in software.
0 = NVM read operation is complete and inactive

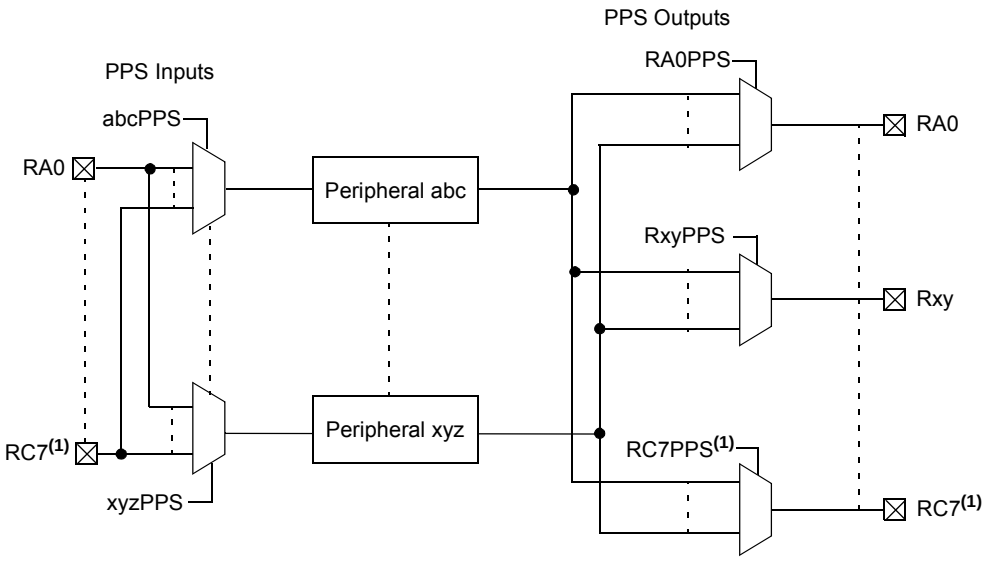
Note 1: Bit is undefined while WR = 1.
2: Bit must be cleared by software; hardware will not clear this bit.
3: Bit may be written to '1' by software in order to implement test sequences.
4: This bit can only be set by following the unlock sequence of **Section 13.3.2 "NVM Unlock Sequence"**.
5: Operations are self-timed, and the WR bit is cleared by hardware when complete.
6: Once a write operation is initiated, setting this bit to zero will have no effect.

15.0 PERIPHERAL PIN SELECT (PPS) MODULE

The Peripheral Pin Select (PPS) module connects peripheral inputs and outputs to the device I/O pins. Only digital signals are included in the selections.

All analog inputs and outputs remain fixed to their assigned pins. Input and output selections are independent as shown in the simplified block diagram Figure 15-1.

FIGURE 15-1: SIMPLIFIED PPS BLOCK DIAGRAM



Note: Not available on 14-Pin devices.

15.1 PPS Inputs

Each peripheral has a PPS register with which the inputs to the peripheral are selected. Inputs include the device pins.

Although every peripheral has its own PPS input selection register, the selections are identical for every peripheral as shown in Register 15-1.

Note:	The notation “xxx” in the register name is a place holder for the peripheral identifier. For example, CLC1PPS.

15.2 PPS Outputs

Each I/O pin has a PPS register with which the pin output source is selected. With few exceptions, the port TRIS control associated with that pin retains control over the pin output driver. Peripherals that control the pin output driver as part of the peripheral operation will override the TRIS control as needed. These peripherals are (See **Section 15.3 “Bidirectional Pins”**):

- EUSART (synchronous operation)
- MSSP (I^2C)

Although every pin has its own PPS peripheral selection register, the selections are identical for every pin as shown in Register 15-2.

Note:	The notation “Rxy” is a place holder for the pin port and bit identifiers. For example, x and y for PORTA bit 0 would be A and 0, respectively, resulting in the pin PPS output selection register RA0PPS.

15.3 Bidirectional Pins

PPS selections for peripherals with bidirectional signals on a single pin must be made so that the PPS input and PPS output select the same pin. Peripherals that have bidirectional signals include:

- EUSART (synchronous operation)
- MSSP (I^2C)

Note:	The I^2C SCLx and SDAx functions can be remapped through PPS. However, only the RB1, RB2, RC3 and RC4 pins have the I^2C and SMBus specific input buffers implemented (I^2C mode disables INLVL and sets thresholds that are specific for I^2C). If the SCLx or SDAx functions are mapped to some other pin (other than RB1, RB2, RC3 or RC4), the general purpose TTL or ST input buffers (as configured based on INLVL register setting) will be used instead. In most applications, it is therefore recommended only to map the SCLx and SDAx pin functions to the RB1, RB2, RC3 or RC4 pins.

15.4 PPS Lock

The PPS includes a mode in which all input and output selections can be locked to prevent inadvertent changes. PPS selections are locked by setting the PPSLOCKED bit of the PPSLOCK register. Setting and clearing this bit requires a special sequence as an extra precaution against inadvertent changes. Examples of setting and clearing the PPSLOCKED bit are shown in Example 15-1.

EXAMPLE 15-1: PPS LOCK/UNLOCK SEQUENCE

```
; suspend interrupts
    BCF     INTCON,GIE
;   BANKSEL PPSLOCK     ; set bank
; required sequence, next 5 instructions
    MOVLW   0x55
    MOVWF   PPSLOCK
    MOVLW   0xAA
    MOVWF   PPSLOCK
; Set PPSLOCKED bit to disable writes or
; Clear PPSLOCKED bit to enable writes
    BSF     PPSLOCK,PPSLOCKED
; restore interrupts
    BSF     INTCON,GIE
```

15.5 PPS Permanent Lock

The PPS can be permanently locked by setting the PPS1WAY Configuration bit. When this bit is set, the PPSLOCKED bit can only be cleared and set one time after a device Reset. This allows for clearing the PPSLOCKED bit so that the input and output selections can be made during initialization. When the PPSLOCKED bit is set after all selections have been made, it will remain set and cannot be cleared until after the next device Reset event.

15.6 Operation During Sleep

PPS input and output selections are unaffected by Sleep.

15.7 Effects of a Reset

A device Power-on-Reset (POR) clears all PPS input and output selections to their default values (Permanent Lock Removed). All other Resets leave the selections unchanged. Default input selections are shown in Table 15-1 and Table 15-2.

23.12 Register Definitions: Comparator Control

REGISTER 23-1: CMxCON0: COMPARATOR Cx CONTROL REGISTER 0

R/W-0/0	R-0/0	U-0	R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0
ON	OUT	—	POL	—	—	HYS	SYNC
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **ON:** Comparator Enable bit
1 = Comparator is enabled
0 = Comparator is disabled and consumes no active power

bit 6 **OUT:** Comparator Output bit
If CxPOL = 1 (inverted polarity):
1 = CxVP < CxVN
0 = CxVP > CxVN
If CxPOL = 0 (noninverted polarity):
1 = CxVP > CxVN
0 = CxVP < CxVN

bit 5 **Unimplemented:** Read as '0'

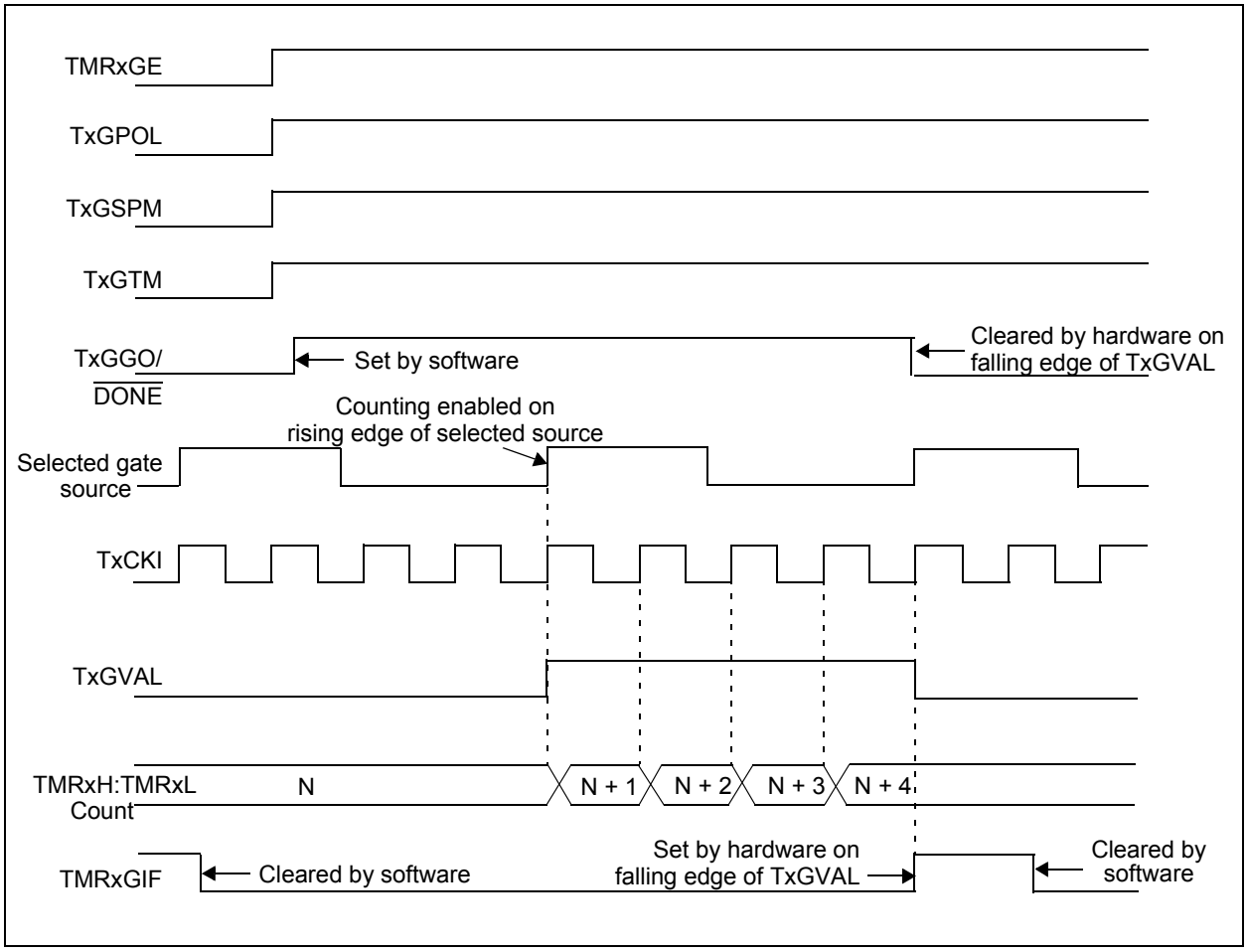
bit 4 **POL:** Comparator Output Polarity Select bit
1 = Comparator output is inverted
0 = Comparator output is not inverted

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **HYS:** Comparator Hysteresis Enable bit
1 = Comparator hysteresis enabled
0 = Comparator hysteresis disabled

bit 0 **SYNC:** Comparator Output Synchronous Mode bit
1 = Comparator output to Timer1 and I/O pin is synchronous to changes on Timer1 clock source. Output updated on the falling edge of Timer1 clock source.
0 = Comparator output to Timer1 and I/O pin is asynchronous

FIGURE 26-6: TIMER1 GATE SINGLE-PULSE AND TOGGLE COMBINED MODE



REGISTER 27-2: T2CON: TIMER2 CONTROL REGISTER

R/W/HC-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ON(1)	CKPS<2:0>			OUTPS<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

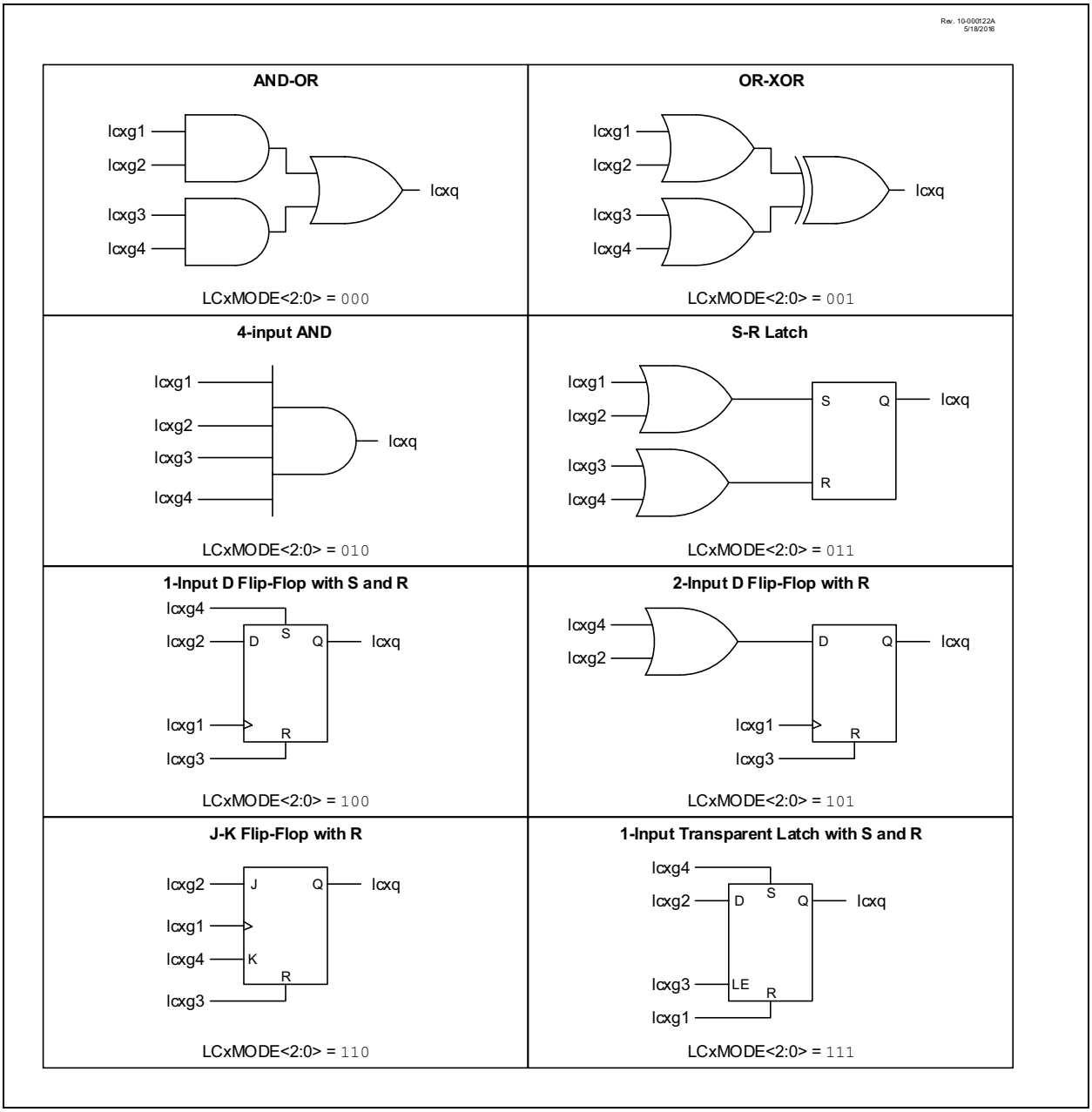
bit 7 **ON:** Timerx On bit
- 1 = Timerx is on
- 0 = Timerx is off: all counters and state machines are reset

bit 6-4 **CKPS<2:0>:** Timer2-type Clock Prescale Select bits
- 111 = 1:128 Prescaler
- 110 = 1:64 Prescaler
- 101 = 1:32 Prescaler
- 100 = 1:16 Prescaler
- 011 = 1:8 Prescaler
- 010 = 1:4 Prescaler
- 001 = 1:2 Prescaler
- 000 = 1:1 Prescaler

bit 3-0 **OUTPS<3:0>:** Timerx Output Postscaler Select bits
- 1111 = 1:16 Postscaler
- 1110 = 1:15 Postscaler
- 1101 = 1:14 Postscaler
- 1100 = 1:13 Postscaler
- 1011 = 1:12 Postscaler
- 1010 = 1:11 Postscaler
- 1001 = 1:10 Postscaler
- 1000 = 1:9 Postscaler
- 0111 = 1:8 Postscaler
- 0110 = 1:7 Postscaler
- 0101 = 1:6 Postscaler
- 0100 = 1:5 Postscaler
- 0011 = 1:4 Postscaler
- 0010 = 1:3 Postscaler
- 0001 = 1:2 Postscaler
- 0000 = 1:1 Postscaler

Note 1: In certain modes, the ON bit will be auto-cleared by hardware. See **Section 27.5 "Operation Examples"**.

FIGURE 31-3: PROGRAMMABLE LOGIC FUNCTIONS



32.6 I²C Master Mode

Master mode is enabled by setting and clearing the appropriate SSPM bits in the SSP1CON1 register and by setting the SSPEN bit. In Master mode, the SDA and SCK pins must be configured as inputs. The MSSP peripheral hardware will override the output driver TRIS controls when necessary to drive the pins low.

Master mode of operation is supported by interrupt generation on the detection of the Start and Stop conditions. The Stop (P) and Start (S) bits are cleared from a Reset or when the MSSP module is disabled. Control of the I²C bus may be taken when the P bit is set, or the bus is Idle.

In Firmware Controlled Master mode, user code conducts all I²C bus operations based on Start and Stop bit condition detection. Start and Stop condition detection is the only active circuitry in this mode. All other communication is done by the user software directly manipulating the SDA and SCL lines.

The following events will cause the SSP Interrupt Flag bit, SSP1IF, to be set (SSP interrupt, if enabled):

- Start condition generated
- Stop condition generated
- Data transfer byte transmitted/received
- Acknowledge transmitted/received
- Repeated Start generated

Note 1: The MSSP module, when configured in I²C Master mode, does not allow queuing of events. For instance, the user is not allowed to initiate a Start condition and immediately write the SSP1BUF register to initiate transmission before the Start condition is complete. In this case, the SSP1BUF will not be written to and the WCOL bit will be set, indicating that a write to the SSP1BUF did not occur

2: When in Master mode, Start/Stop detection is masked and an interrupt is generated when the SEN/PEN bit is cleared and the generation is complete.

32.6.1 I²C MASTER MODE OPERATION

The master device generates all of the serial clock pulses and the Start and Stop conditions. A transfer is ended with a Stop condition or with a Repeated Start condition. Since the Repeated Start condition is also the beginning of the next serial transfer, the I²C bus will not be released.

In Master Transmitter mode, serial data is output through SDA, while SCL outputs the serial clock. The first byte transmitted contains the slave address of the receiving device (7 bits) and the Read/Write (R/$\overline{W}$) bit. In this case, the R/$\overline{W}$ bit will be logic '0'. Serial data is transmitted eight bits at a time. After each byte is transmitted, an Acknowledge bit is received. Start and Stop conditions are output to indicate the beginning and the end of a serial transfer.

In Master Receive mode, the first byte transmitted contains the slave address of the transmitting device (7 bits) and the R/$\overline{W}$ bit. In this case, the R/$\overline{W}$ bit will be logic '1'. Thus, the first byte transmitted is a 7-bit slave address followed by a '1' to indicate the receive bit. Serial data is received via SDA, while SCL outputs the serial clock. Serial data is received eight bits at a time. After each byte is received, an Acknowledge bit is transmitted. Start and Stop conditions indicate the beginning and end of transmission.

A Baud Rate Generator is used to set the clock frequency output on SCL. See **Section 32.7 "Baud Rate Generator"** for more detail.

FIGURE 32-34: BUS COLLISION DURING START CONDITION (SCL = 0)

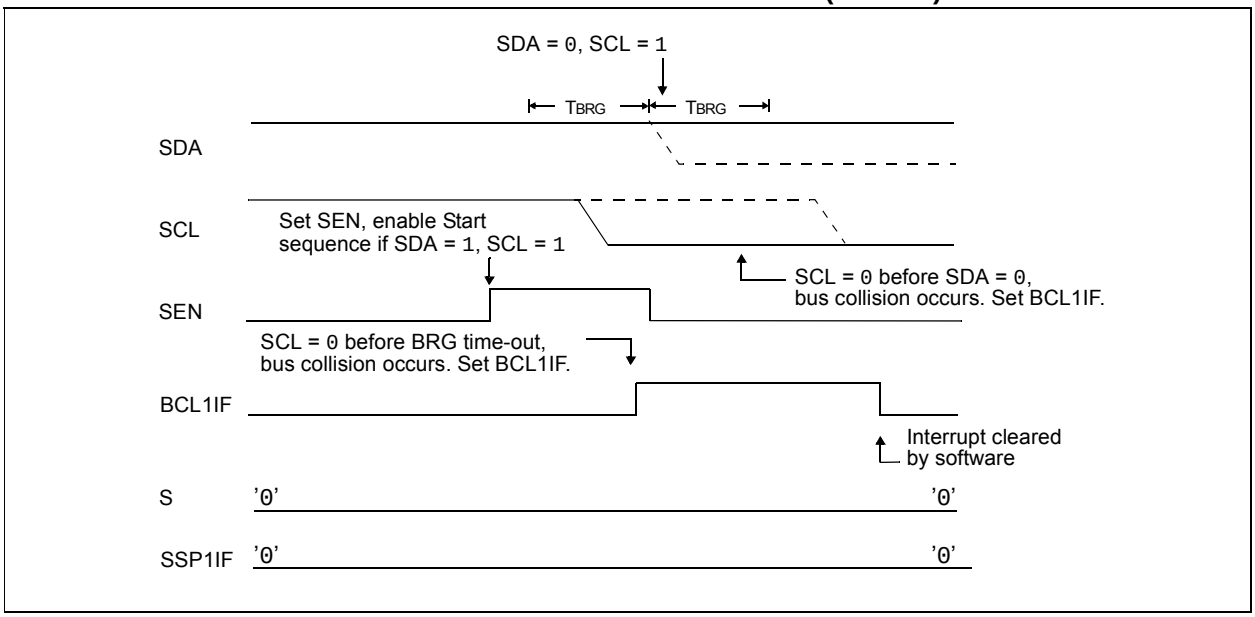
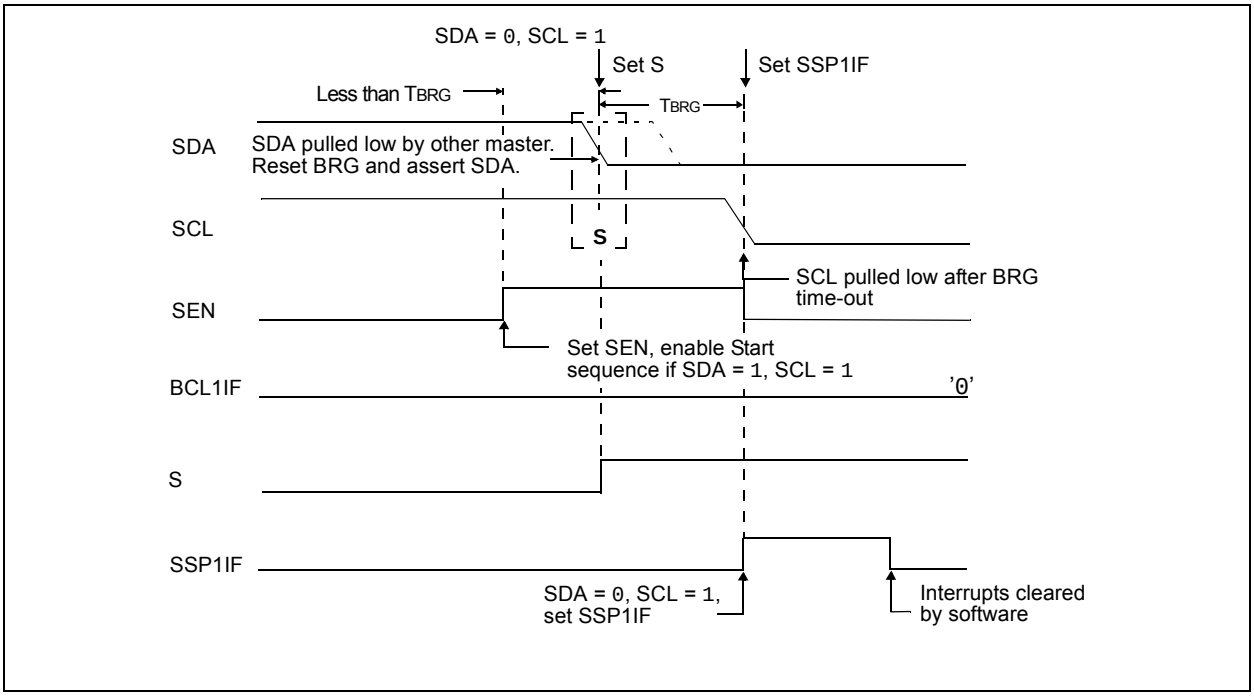
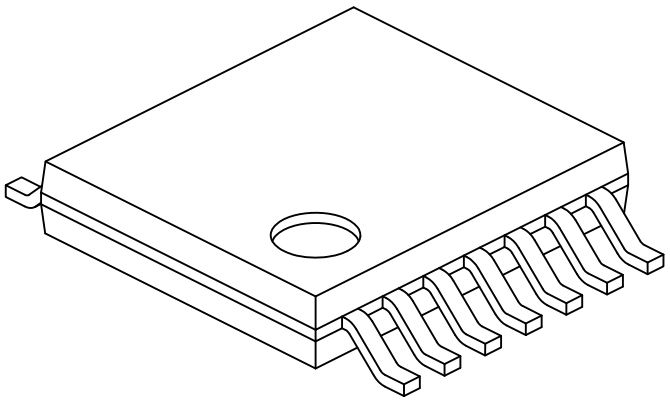


FIGURE 32-35: BRG RESET DUE TO SDA ARBITRATION DURING START CONDITION



14-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		14	
Pitch	e		0.65 BSC	
Overall Height	A	-	-	1.20
Molded Package Thickness	A2	0.80	1.00	1.05
Standoff	A1	0.05	-	0.15
Overall Width	E		6.40 BSC	
Molded Package Width	E1	4.30	4.40	4.50
Molded Package Length	D	4.90	5.00	5.10
Foot Length	L	0.45	0.60	0.75
Footprint	(L1)		1.00 REF	
Foot Angle	φ	0°	-	8°
Lead Thickness	c	0.09	-	0.20
Lead Width	b	0.19	-	0.30

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-087C Sheet 2 of 2